## **ARES-1983H Series**

Compact Embedded Computer supports Intel® 14th/13th/12th Gen. Core™ i9/i7/i5/i3 Processor

## **User's Manual**

Version 1.1



P/N: 4016198300110P

## **Revision History**

Version	Date	Description
1.0	2023.09	Initial release
1.1	2024.12	Product images update

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## **Copyright Notice**

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## **Declaration of Conformity**

## CE

The CE symbol on your product indicates that it is in compliance with the directives of the Union European (EU). A Certificate of Compliance is available by contacting Technical Support.

This product has passed the CE test for environmental specifications when shielded cables are used for external wiring. We recommend the use of shielded cables. This kind of cable is available from ARBOR. Please contact your local supplier for ordering information.

## Warning

This is a class A product. In a domestic environment this product may cause radio interference in which case the user may be required to take adequate measures.

### **FCC Class A**

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions:

- (1) This device may not cause harmful interference, and
- (2) This device must accept any interference received, including interference that may cause undesired operation.

### NOTE:

This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

## **RoHS**

ARBOR Technology Corp. certifies that all components in its products are in compliance and conform to the European Union's Restriction of Use of Hazardous Substances in Electrical and Electronic Equipment (RoHS) Directive 2002/95/EC.

The above mentioned directive was published on 2/13/2003. The main purpose of the directive is to prohibit the use of lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls (PBB), and polybrominated diphenyl ethers (PBDE) in electrical and electronic products. Member states of the EU are to enforce by 7/1/2006.

ARBOR Technology Corp. hereby states that the listed products do not contain unintentional additions of lead, mercury, hex chrome, PBB or PBDB that exceed a maximum concentration value of 0.1% by weight or for cadmium exceed 0.01% by weight, per homogenous material. Homogenous material is defined as a substance or mixture of substances with uniform composition (such as solders, resins, plating, etc.). Lead-free solder is used for all terminations (Sn(96-96.5%), Aq(3.0-3.5%) and Cu(0.5%)).

### SVHC / REACH

To minimize the environmental impact and take more responsibility to the earth we live, Arbor hereby confirms all products comply with the restriction of SVHC (Substances of Very High Concern) in (EC) 1907/2006 (REACH --Registration, Evaluation, Authorization, and Restriction of Chemicals) regulated by the European Union.

All substances listed in SVHC < 0.1 % by weight (1000 ppm)

## **Important Safety Instructions**

Read these safety instructions carefully

- 1. Read all cautions and warnings on the equipment.
- 2. Place this equipment on a reliable surface when installing. Dropping it or letting it fall may cause damage
- 3. Make sure the correct voltage is connected to the equipment.
- 4. For pluggable equipment, the socket outlet should be near the equipment and should be easily accessible.
- 5. Keep this equipment away from humidity.
- 6. The openings on the enclosure are for air convection and protect the equipment from overheating. DO NOT COVER THE OPENINGS.
- 7. Position the power cord so that people cannot step on it. Do not place anything over the power cord.
- 8. Never pour any liquid into opening. This may cause fire or electrical shock.
- 9. Never open the equipment. For safety reasons, the equipment should be opened only by qualified service personnel.
- 10. If one of the following situations arises, get the equipment checked by service personnel:
  - The power cord or plug is damaged.
  - b. Liquid has penetrated into the equipment.
  - c. The equipment has been exposed to moisture.
  - d. The equipment does not work well, or you cannot get it to work according to the user's manual.
  - e. The equipment has been dropped or damaged.
  - f. The equipment has obvious signs of breakage.
- 11. Keep this User's Manual for later reference.

## Warning

The Box PC and its components contain very delicately Integrated Circuits (IC). To protect the Box PC and its components against damage caused by static electricity, you should always follow the precautions below when handling it:

- Disconnect your Box PC from the power source when you want to work on the inside.
- 2. Use a grounded wrist strap when handling computer components.
- 3. Place components on a grounded antistatic pad or on the bag that came with the Box PC, whenever components are separated from the system.

## **Lithium Battery Replacement**

Incorrect replacement of the lithium battery may lead to a risk of explosion.

The lithium battery must be replaced with an identical battery or a battery type recommended by the manufacturer.

Do not throw lithium batteries into the trash can. It must be disposed of in accordance with local regulations concerning special waste.

## **Technical Support**

If you have any technical difficulties, please consult the user's manual first at: https://www.arbor-technology.com

Please do not hesitate to call or e-mail our customer service when you still cannot find out the answer.

https://www.arbor-technology.com

E-mail: info@arbor.com.tw

## Warranty

This product is warranted to be in good working order for a period of one year from the date of purchase. Should this product fail to be in good working order at any time during this period, we will, at our option, replace or repair it at no additional charge except as set forth in the following terms. This warranty does not apply to products damaged by misuse, modifications, accident or disaster.

Vendor assumes no liability for any damages, lost profits, lost savings or any other incidental or consequential damage resulting from the use, misuse of, or inability to use this product. Vendor will not be liable for any claim made by any other related party.

Vendors disclaim all other warranties, either expressed or implied, including but not limited to implied warranties of merchantability and fitness for a particular purpose, with respect to the hardware, the accompanying product's manual(s) and written materials, and any accompanying hardware. This limited warranty gives you specific legal rights.

Return authorization must be obtained from the vendor before returned merchandise will be accepted. Authorization can be obtained by calling or faxing the vendor and requesting a Return Merchandise Authorization (RMA) number. Returned goods should always be accompanied by a clear problem description.

## Chapter 1

## Introduction

## 1.1. Features

- Socket LGA1700 for Intel<sup>®</sup> 14<sup>th</sup>/13<sup>th</sup>/12<sup>th</sup> Core<sup>™</sup> i9/i7/i5/i3 Processor
- Fansink Design Active Cooling without internal Dust Accumulation
- Modular Design Easily expandable and customizable
- Support up to 6 x USB & 7 x LAN(4 w/ PoE)
- Dual-Display for 1 x VGA and 1 x DisplayPort
- DI/DO with 1.5KV Isolation Protection, DI supports Connection of Dry & Wet Contact Devices
- M.2 2242/2280 M-Key Slot support SATA & NVMe(Gen4 x4)
- 2 x Internal USB 2.0 Type-A ports for HW License Key & Security Dongle

## 1.2. About this Manual

This manual is meant for the experienced users and integrators with hardware knowledge of personal computers. If you are not sure about the description in this manual, consult your vendor before further handling.

We recommend that you keep one copy of this manual for the quick reference for any necessary maintenance in the future. Thank you for choosing ARBOR products.

The ARES-1983H series includes the following models:

	Outlook	Description
ARES-1983H	48	ARES-1983 w/ H610E Chipset, 3 x LAN, 2 x COM, 6 x USB, 1 x DP, 1 x VGA, 1 x M.2 E-Key, 1 x mPCle & 1 x M.2 M-Key
ARES-1983H-MV	WIND H	ARES-1983H w/ 4 x GbE PoE,16 x isolated DI + 16 x isolated DO & 1 x 2.5" SSD/HDD tray

## 1.3. Specifications

System		
CPU	Intel® 14 <sup>th</sup> /13 <sup>th</sup> /12 <sup>th</sup> Core™ i9/i7/i5/i3 processor in LGA1700 Socket (Max.65W)	
Memory 1 x 262-pin DDR5 SO-DIMM sockets, supporting 5600MHz SDRAM up to 32GB		
Chipset	Intel® H610E	
Graphics	Integrated Intel® UHD Graphics 730/770	
LAN Chipset	1 x Intel® i226LM 1 x Intel® i219LM 5 x Intel® i210AT (4 x for GbE PoE)	
Watchdog Timer	1~255 levels reset	
ТРМ	dTPM 2.0	
I/O		
Serial Port	1 x RS232 <sub>(Default)</sub> /422/485 1 x RS232	
USB Port	2 x USB-A 3.2 Gen2 (10Gbps) 2 x USB-A 3.2 Gen1 (5Gbps) 2 x USB-A 2.0 2 x internal USB-A 2.0	
LAN	1 x 2.5GbE ports 2 x GbE ports 4 x GbE PoE ports(IEEE802.3af) (For ARES-1983H-MV)	
Video Dout	1 x DisplayPort 1.4, up to 4096x2304@60Hz	
Video Port	1 x VGA, up to 1920x1200@60Hz	
Digital I/O  16 x DI & 16 x DO w/ 1.5kV isolation (For ARES-1983H-MV)		
	1 x M.2 E-key 2230 slot (PCle 3.0 x1 + USB2.0 + CNVi)	
Expansion Bus	1 x mPCle (PCle 3.0 x1 + USB 2.0, Full size) w/ 1 x nano SIM card slot	
Others	4 x Antenna holes	

Storage			
Туре	1 x M.2 M-key 2242/2280 slot (PCIe 4.0 x4 + SATA)		
	1 x 2.5" HDD/SSD internal drive bay		
	(For ARES-1983H-MV)		
Environmental			
Operating Temp.	w/ 35W TDP CPU: -20 ~ 60°C, ambient w/ air flow		
oporating romp.	w/ 65W TDP CPU: -20 ~ 50°C, ambient w/ air flow		
Storage Temp.	-30 ~ 70°C		
Operating Humidity	10-95% @ 60°C (non-condensing)		
Vibration	5~500Hz 3 Grms X,Y,Z axis w/SSD, according to IEC 68-2-64		
	10G peak acceleration (11 m sec. duration), operation		
Shock	30G peak acceleration (11 m sec. duration), nonoperation		
	According to IEC 68-2-27		
Qualification			
Certification CE, FCC Class A			
Power Requirement			
Power Input	DC 12~24V via 2-pin terminal block		
Max. Power	ARES-1983H (w/ 65W TDP CPU): 110W		
Consumption	ARES-1983H-MV(w/ 65W TDP CPU): 170W		
Mechanical			
Construction	Metal + Aluminum		
Mounting	Wall-mount (standard)		
wounting	DIN-rail (optional w/ CTOS bracket)		
Weight	ARES-1983H: 2.5kg		
TTOIGHT	ARES-1983H-MV: 3.1kg		
Dimensions	ARES-1983H: 55 x 164 x 210mm		
(W x D x H)	ARES-1983H-MV: 90 x 164 x 210mm		
OS Support			
Windows 10 / Windo	ows 11 / Ubuntu		

## 1.4. Inside the Package

Upon opening the package, carefully inspect the contents. If any of the items is missing or appears damaged, contact your local dealer or distributor. The package should contain the following items:





1 x ARES-1983H / ARES-1983H-MV

## **ARES-1983H**

1 x Accessory Box that contains the following items:

- User's manual
- 2 x 2-pin terminal block plug
- 6 x M3\*4L screws (for wall mount bracket)
- 1 x Wall mounting bracket (Pair)
- 1 x Thermal grease



### ARES-1983H-MV

- User's manual
- 2 x 2-pin terminal block plug
- 2 x 19-pin terminal block plug
- 8 x M3 4mm screws (for 2.5" drive & tray)
- 6 x M3\*4L screws (for wall mount bracket)
- 1 x Wall mounting bracket (Pair)
- 1 x 2.5" HDD/SSD bracket
- 1 x Thermal grease

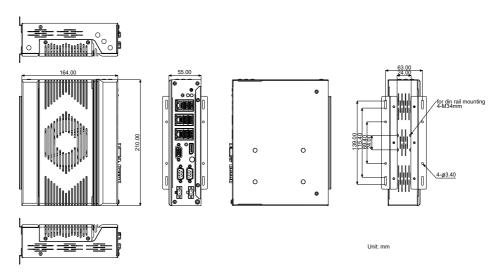


## Chapter 2

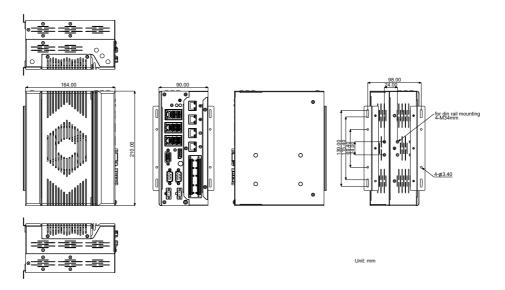
**Getting Started** 

## 2.1. Dimensions

## **ARES-1983H**

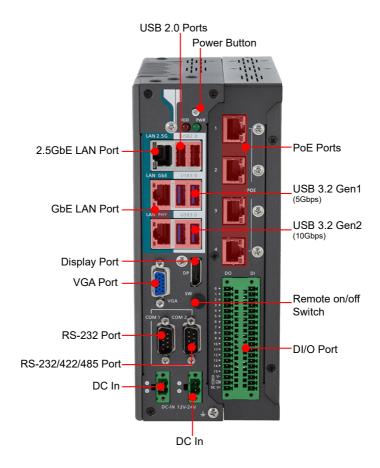


## ARES-1983H-MV



## 2.2. Overview

## 2.2.1. Front View (ARES-1983-MV)



## **DC In Connector**

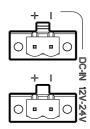
Connector Type: 2.54mm pitch 2-pin terminal Block

Pin Assignment: Pin

Pin Description

1 DC in (+)

2 Ground (-)



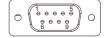
**Note**: Please note that one DC in is enough to power up the device. Select either one for DC input and the other one could be output to provide additional power.

## **COM Connector**

Connector Type: 9-pin D-sub Male Connector

Pin Assignment:

	RS-232	RS-422	RS-485	
Pin	Signal name			
1	DCD	COM_422 TX-	COM_485 D-	
2	RXD	COM_422 TX+	COM_485 D+	
3	TXD	COM_422 RX+		
4	DTR	COM_422 RX-		
5	GND	GND	GND	
6	DSR			
7	RTS			
8	CTS			
9	RI			



## 2.2.2. LED Indicator Status

LED Indicator	Color	Description
PWR Button	Green	Solid: The system is in operation(S0)
	Red	Solid: The system is in in sleep/hibernate mode(S3/S4) or power off mode(S5)
PWR LED	Solid Green	Solid: The system is powered on
SATA HDD/SSD	Red	Flashing: Data is transmitting
	Yellow	Solid: Link is established
		Flashing: Data is transmitting
GbE LAN	Green/Orange	Orange: 1 Gbit/s connection
		Green: 100 Mbit/s connection
		Off: 10 Mbit/s connection
	Yellow	Solid: Link is established
	reliow	Flashing: Data is transmitting
2.5GbE LAN	Green/Orange	Orange: 2.5 Gbit/s connection
		Green: 1 Gbit/s connection
		Off: 10/100 Mbit/s connection

## 2.3. Driver Installation Note

For operating system of Windows 10, please go to our website at **www.arbor-technology.com** and download the driver pack from the product page. Then unzip the downloaded file and follow the sequence below to install the drivers to prevent errors:

## $\textbf{Chipset} \rightarrow \textbf{Other drivers}$

The driver path is listed as below:

## Windows 10

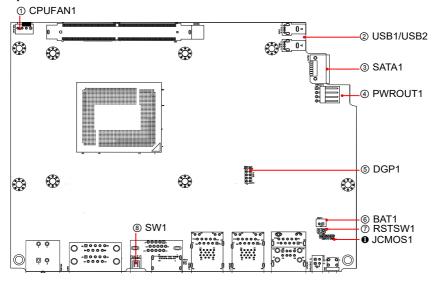
Driver	Path	
Chipset	\WIN10\Chipset\SetupChipset.exe	
Graphics	Graphics \WIN10\Graphics\win64\Installer.exe	
Intel ME \WIN10\ME\Main_DCH\SetupME.exe		
Intel Serial IO \WIN10\Intel Serial IO\SetupSerialIO.exe		
LAN	\WIN10\LAN\Wired_driver_27.7_x64\Wired_driver_27.7_x64.exe	

## Chapter 3

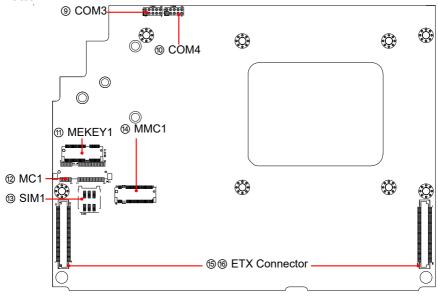
# **Engine of the Computer**

## 3.1. Main Board - FMB-i93Q0

## Top:



## **Bottom:**



## 3.1.1. Jumper & Connectors

## Jumper

Label	Description	
1 JCMOS1	Clear CMOS Jumper	

## **Connectors**

Label	Description
① CPUFAN1	System Fan Connector
② USB1/USB2	USB 2.0 Type-A Connector
③ SATA1	SATA 7-pin Connector
④ PWROUT1	SATA Power Connector
⑤ DGP1	Debug Port
⑥ BAT1	RTC Battery Connector
⑦ RSTSW1	Reset Button (Reserved for OEM products)
8 SW1	Remote Control
9 COM3	RS-232/RS-422/RS-485 Serial Port Header (Reserved for OEM products)
@ COM4	RS-232 Serial Port Header (Reserved for OEM products)
① MEKEY1	M.2 E-Key Socket
② MC1	Mini PCI-e Socket
③ SIM1	Nano SIM Card Socket
4 MMC1	M.2 M-Key Socket
(5) (6) ETX Connector	Daughter Board Connector

## 3.1.2. Jumper & Connectors Settings

## JCMOS1

Function: Clear CMOS Selection

Jumper Type: 2.00mm pitch 2-pin Header

Setting: Cond. Description

Short Clear CMOS 1 2

Open Keep CMOS (default) 1 0 2

## ① CPUFAN1

Function: Fan Power Connector

Connector Type: 2.54mm pitch 4-pin Wafer

Pin Assignment: Pin Description

1	GND
2	+12V
3	RPM
4	Control



## **② USB1/USB2**

Function: USB 2.0 Type-A Connector Connector Type: USB 2.0 Type-A Connector

Pin Assignment: The pin assignment conform to the industry standard.





## **3 SATA1**

Function: SATA 7-pin Connector

Connector Type: Standard 7-pin Serial ATA Connector

Pin Assignment:

	Pin	Description	Pin	Description
	1	GND	2	TX+
	3	TX-	4	GND
	5	RX-	6	RX+
	7	GND		



## **4 PWROUT1**

Function: SATA Power Connector

Connector Type: 2.54mm pitch 4-pin Wafer

Pin Assignment: Pin Description

PIII	Description
1	+5V
2	GND
3	GND
4	+12V



## ⑤ DGP1

Function: Debug Port

Connector Type: 2.00mm pitch 10-pin Header

Pin Assignment:

Pin	Description	Pin	Description
1	ESPI_CLK	2	GND
3	ESPI_CS0#	4	ESPI_IO0
5	ESPI_RST#	6	V3.3A
7	ESPI_IO3	8	ESPI_IO2
9	V3.3S	10	ESPI_IO1



## **6 BAT1**

Function: RTC Battery Connector

Connector Type: 2-pin Box Header

Pin Assignment: Pin Description

Pin	Description
1	BAT+
2	BAT-



## ⑦ RSTSW1

Function: Reset Button
Connector Type: 2-pin Header

Pin Assignment: Pin Description

	Booonpaon
1	FR_RST#
2	GND



**® SW1** 

Function: Remote Control

Connector Type: 2-pin Header(S2B-PH-K-S)

Pin Assignment: Pin Description

1 PWR\_IN\_SW#
2 GND

**9 COM3** 

Function: RS-232/RS-422/RS-485 Serial Port Header

Connector Type: 2.00mm pitch 9-pin Header

Pin Assignment: Pin

Pin	RS-232	RS-422	RS-485
1	DCD	COM_422 TX-	COM_485 D-
2	RXD	COM_422 TX+	COM_485 D+
3	TXD	COM_422 RX+	
4	DTR	COM_422 RX-	
5	GND	GND	GND
6	DSR		
7	RTS		
8	CTS		
9	RI		

**10 COM4** 

Function: RS232 Serial Port Header
Connector Type: 2.00mm pitch 9-pin Header

Pin Assignment:

	Pin	Description	Pin	Description
	1	DCD	2	RXD
	3	TXD	4	DTR
	5	GND	6	DSR
	7	RTS	8	CTS
	9	RI		

## ① MEKEY1

Function: M.2 E-Key Socket (w/ PCle 3.0 x1 + USB 2.0) for Wi-Fi/

BT

Connector Type: M.2 E-Key 2230 Socket

Pin Assignment: The pin assignments conform to the industry standard.



**@ MC1** 

Function: Full-size mini PCI-e Socket (w/ PCIe 3.0 x1 + USB 2.0)

Connector Type: Mini PCI-e 52-pin Socket

Pin Assignment: The pin assignments conform to the industry standard.



**® SIM1** 

Function: Nano SIM Card Socket

Connector Type: Nano SIM Card Socket

Pin Assignment: The pin assignments conform to the industry standard.



**(4) MMC1** 

Function: M.2 M-Key Socket (w/ PCle 4.0 x4 + SATA) for storage or expansion module

Connector Type: M.2 M-Key 2242/2280 Socket

Pin Assignment: The pin assignments conform to the industry standard.



## 15 66 ETX Connector

Function: Daughter Board Connector

Connector Type: 100-pin Connector

Pin Assignment: ARBOR original design pin out

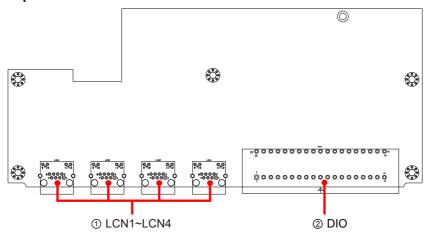
For requirement of customized daughter board, please contact ARBOR.

## 3.2. Daughter Board - SCDB-348D (For ARES-1983H-MV)

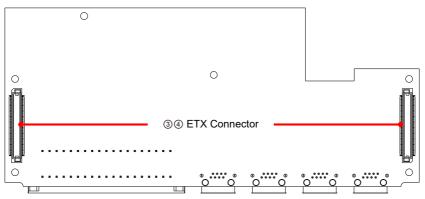
Function: PoE and isolated digital I/O daughter board

Applicable models: ARES-1983H-MV

## Top:



## **Bottom**



## 3.2.1. Connectors Settings

## ① LCN1~LCN4

Function: 1GbE PoE (IEEE 802.3af)

Connector Type: RJ-45 Connector

Pin Assignment: The pin assignments conform to the industry standard.

**② DIO** 

Function: Digital Input & Output
Connector Type: 38-pin Terminal Block

Pin Assignment:

Pin	Description	Pin	Description		
1	DOUT_00	20	DIN_00		
2	DOUT_01	21	DIN_01		
3	DOUT_02	22	DIN_02	DO	DI
4	DOUT_03	23	DIN_03	- 	O 186-1
5	DOUT_04	24	DIN_04	1 5	
6	DOUT_05	25	DIN_05	2 D 100 1	
7	DOUT_06	26	DIN_06		
8	DOUT_07	27	DIN_07	6	
9	DOUT_08	28	DIN_08	80	
10	DOUT_09	29	DIN_09	9 10	
11	DOUT_10	30	DIN_10	11 6 1	
12	DOUT_11	31	DIN_11	13	
13	DOUT_12	32	DIN_12	15	
14	DOUT_13	33	DIN_13		
15	DOUT_14	34	DIN_14	NCV+ DOC!	
16	DOUT_15	35	DIN_15	0	O
17	GND_ISO	36	GND_24V_ISO		
18	GND_ISO	37	COM1		
19	NC	38	+24V_IS		

## **34 ETX Connector**

Function: Daughter Board Connector

Connector Type: 100-pin Connector

Pin Assignment: ARBOR original design pin out

For requirement of customized daughter board, please contact ARBOR.



## **Chapter 4**

# Installation & Maintenance

## 4.1. Disassembling and Assembling the Computer

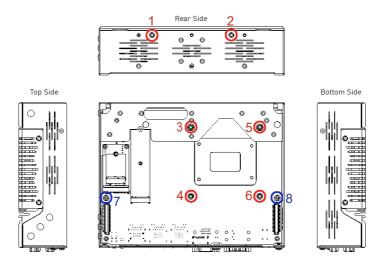
## 4.1.1 Disassembling the Computer (ARES-1983H)

To use onboard jumpers/connectors or to install/remove internal components, you will need to open the computer to access the inside of the computer. Follow through the guide below to disassemble the computer.

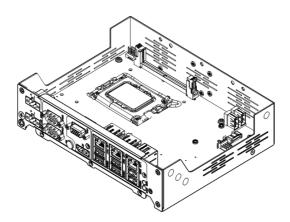
Step 1. Remove the bottom plate by unscrewing 4 screws.



Step 2. Remove the heat sink by unscrewing 6 screws and 2 long nuts.



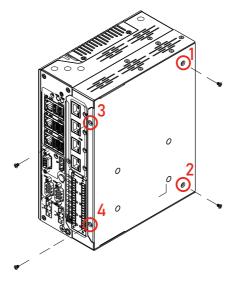
Step 3. Turn it to the other side to install CPU and memory module.



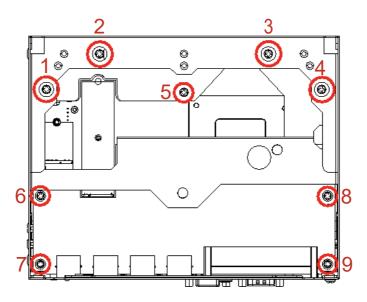
## 4.1.2. Disassembling the Computer (ARES-1983H-MV)

To use onboard jumpers/connectors or to install/remove internal components, you will need to open the computer to access the inside of the computer. Follow through the guide below to disassemble the computer.

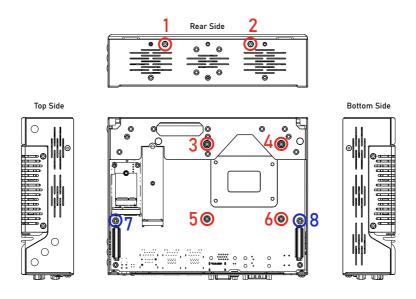
Step 1. Remove the bottom plate by unscrewing 4 screws.



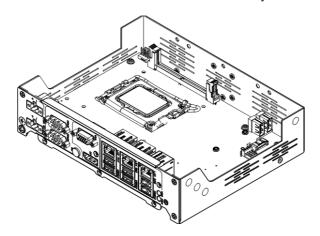
Step 2. Remove the second layer by unscrewing 9 screws.



Step 3. Remove the heat sink by unscrewing 6 screws and 2 long nuts..



Step 4. Turn it to the other side to install CPU and memory module.





Bottom side of the main board

Top side of the main board



# 4.1.3. Assembling the Computer

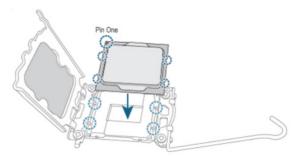
After completing the required hardware installation and jumpers settings, assemble the computer as above figure.

## 4.2. Installing Hardware

## 4.2.1. Installing CPU

- 1. Remove the top and side cover from the computer as described in 4.1. Disassembling and Assembling the Computer on page 24
- Locate the CPU socket on the main board
   The processor socket comes with a mylar sticker to secure the processor.
   Please refer to the pictures step by step as below and note that the cover of the socket must always be installed during transportation to avoid damage to the socket.



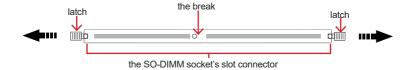


#### 4.2.2. Installing Memory Module

- Remove the top cover from the computer as described in
   1. Disassembling and Assembling the Computer on page 24
- 2. Locate the SO-DIMM sockets on the main board.

The SO-DIMM sockets are vertical type, and each socket has two latches for fixing the memory modules. The memory module can only be installed by one direction due to the notch.

3. Pull back both latches from the socket.



vertical-type SO-DIMM socket (overview)

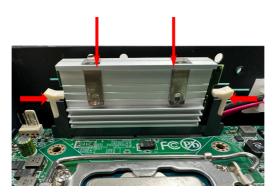
- 4. Confront the memory module's golden finger at the SO-DIMM socket. Position the memory module at the SO-DIMM socket, with the memory module's key notch aligned at the break of the SO-DIMM's slot connector.
- 5. Locate memory module sockets.



6. Align the notch on the memory module with the key in the module socket.



7. Vertically plug the memory module to the DIMM socket. "Fully" plug the memory module until both latches auto-lock the memory module in place.



# 4.2.3. Installing a 2.5" SSD or HDD

- 1. Remove the bottom cover from the computer as described in 4.1.2. Disassembling the Computer (ARES-1983H-MV) on page 25.
- 2. Using 4 x M3\*4 screws coming with the storage device kit to install a 2.5" HDD or SSD storage device into the drive bay.



3. Using the other 4 x M3\*4 screws to fix the drive bay to the bottom cover.



- 4. Connect the cables assembled inside to the SATA drive.
- 5. Close the cover.

Note: Only **ARES-1983H-MV** is available to install 2.5" HDD or SSD storage device.

## 4.2.4. Installing a M.2 Module

The computer has a M.2 M-Key socket for NVMe or SATA SSD. This section will use a 22 x 80 form factor as the installation example.

1. Remove the bottom cover from the computer as described in <u>4.1.</u>

<u>Disassembling and Assembling the Computer on page 24</u>. Then locate the M.2 on-board connector.

#### ARES-1983H



#### ARES-1983H-MV



2. Insert the M.2 module into the socket by aligning the notch on the module with the small slot on the M.2 socket.



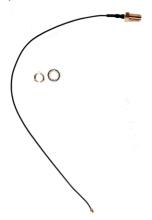
3. Insert and fasten the screw into the standoff.

## 4.2.5. Installing WI-FI connection module and antenna

- 1. Remove the bottom cover from the computer as described in <u>4.1.2.</u> <u>Disassembling the Computer (ARES-1983H-MV) on page 25.</u>
- 2. Locate the M.2 E-Key socket for wireless module.



3. Prepare the Wi-Fi module kit. The module is a **M.2 E-Key** socket form factor, with two MHF connectors, one is "MAIN", and the other is "AUX".

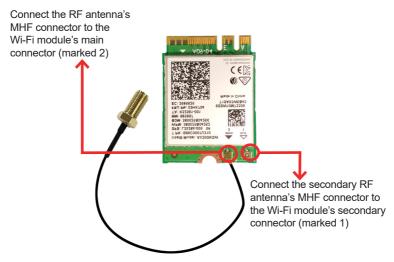


Two MHF connectors, one is "MAIN" (marked 2), the other is "AUX" (marked 1).



4. Have the RF antenna. The antenna has an SMA connector on one end and an MHF connector on the other.

5. Connect the RF antenna's MHF connector to the Wi-Fi module's main connector marked 0. If you are going to connect a secondary antenna, connect it to the connector marked



6. Plug the Wi-Fi module to the socket's connector by a slanted angle. Fully plug the module, and note that the notch on the wireless module should meet the break of the connector, then fasten the screw.

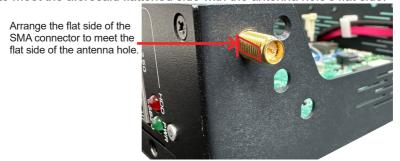


7. Locate the SMA antenna holes and. Remove the plastic plug(s) from the computer's top panel side to make antenna hole(s). Keep the plastic plug for any possible restoration in the future.

8. From the other end of the RF antenna, which is an SMA connector, remove the washer and the nut. Note the SMA connector has the form of a threaded bolt, with one flat side.



9. Pull the SMA connector through the above mentioned antenna hole. Note to meet the aforesaid flattened side with the antenna hole's flat side.



 Mount the washer first and then the nut to the SMA connector. Make sure the nut is tightened.

Mount the washer and the

nut to the SMA connector.



11. After completing the required hardware installation, assemble the computer by performing the proceeding steps in reverse order.

# 4.2.6. Installing a SIM Card and relative connection module

This section will guide you how to install a SIM card and relative connection module.

- 1. Remove the bottom cover from the computer as described in <u>4.1.2.</u> Disassembling the Computer (ARES-1983H-MV) on page 25.
- 2. Locate the SIM card slot on the main board.



3. Slide the SIM card holder cover towards the OPEN edge and then lift the cover to open it.



4. Insert the SIM card into the card holder as shown below.

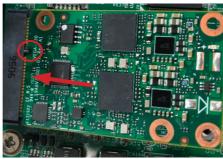


5. Close the SIM card holder door and slide the door to the LOCK edge to lock into place.



6. Locate the MC1 slot and insert the relative communication module then fasten the screw.



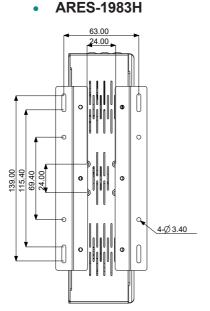


# 4.3. Mounting

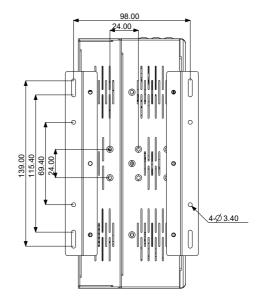
#### 4.3.1. Wall Mounting

To wall mount the computer using the provided wall-mount kit:

- 1. Select a proper mounting location with adequate wall strength to support the mounted unit.
- 2. Locate the 6 screw holes on the computer's rear side. Use the screws (M3x4L, qty:6) included in the wall-mount kit to assemble the brackets to the computer's rear side.
- 3. Use the other screw holes and cutouts on both wall-mount brackets to mount the computer to a wall.



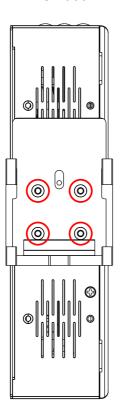
## ARES-1983H-MV



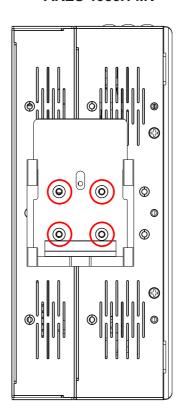
# 4.3.2. DIN-Rail Mounting

To mount the computer using the optional DIN-rail mounting kit:

- 1. Select a proper mounting location with adequate wall strength to support the mounted unit.
- 2. Screw the DIN-rail mounting clip with included screws (M3x5mm, qty:4) to the rear side of the computer as below.
  - ARES-1983H

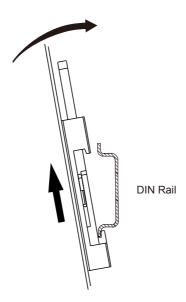


## ARES-1983H-MV



After you screw the DIN-rail mounting clip to the computer:

- 1. Snap the DIN Rail clip to the lower edge of the DIN Rail.
- 2. Press the computer firmly upward towards the DIN Rail until the DIN Rail clip tab engages and snaps to the upper edge of the DIN Rail.



# **Chapter 5**

**BIOS** 

The BIOS Setup utility is featured by American Megatrends Inc to configure the system settings stored in the system's BIOS ROM. The BIOS is activated once the computer powers on. When the computer is off, the battery on the main board supplies power to BIOS RAM.

To enter the BIOS Setup utility, keep hitting the "Delete" key upon powering on the computer.



Note: Actual model name and board information varies according to your model.

Menu	Description	
Main	See <u>5.1. Main on page 46</u>	
Advanced	See <u>5.2. Advanced on page 47</u>	
Chipset	See <u>5.3. Chipset on page 66</u>	
Security	See <u>5.4. Security on page 75</u>	
Boot	See <u>5.5. Boot on page 77</u>	
Save & Exit	See <u>5.6. Save &amp; Exit on page 78</u>	

## **Key Commands**

The BIOS Setup utility relies on a keyboard to receive user's instructions. Hit the following keys to navigate within the utility and use the utility.

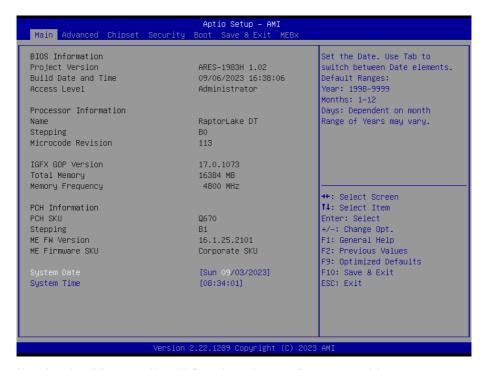
Keystroke	Function
$\leftarrow$ $\rightarrow$	Moves left/right between the top menus.
↓ ↑	Moves up/down between highlight items.
Enter	Selects an highlighted item/field.
	➤ On the top menus:
Esc	Use <b>Esc</b> to quit the utility without saving changes to CMOS. (The screen will prompt a message asking you to select <b>OK</b> or <b>Cancel</b> to exit discarding changes.
	➤ On the submenus:
	Use <b>Esc</b> to quit current screen and return to the top menu.
Page Up / +	Increases current value to the next higher value or switches between available options.
Page Down / -	Decreases current value to the next lower value or switches between available options.
F1	Opens the <b>Help</b> of the BIOS Setup utility.
F10	Exits the utility saving the changes that have been made. (The screen then prompts a message asking you to select <b>OK</b> or <b>Cancel</b> to exit saving changes.)

Note: Pay attention to the "WARNING" that shows at the left pane onscreen when making any change to the BIOS settings.

This BIOS Setup utility is updated from time to time to improve system performance and hence the screenshots hereinafter may not fully comply with what you actually have onscreen.

#### 5.1. Main

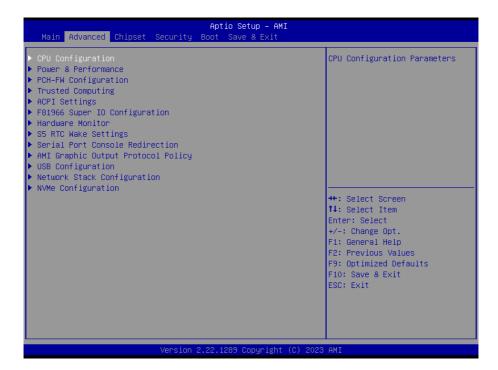
The **Main** menu features the settings of **System Date** and **System Time** and displays some BIOS info.



Note: Actual model name and board information varies according to your model.

Setting	Description	
Project Version	Delivers the model name of the computer and BIOS version.	
Build Date and Time	Delivers the date and time when the BIOS Setup utility was made/ updated.	
Access Level	Delivers the level that the BIOS is being accessed at the moment.	
System Date	Sets system date.	
System Time	Sets system time.	

#### 5.2. Advanced



Setting	Description	
CPU Configuration	See <u>5.2.1. CPU Configuration on page 48</u>	
Power & Performance	See 5.2.2. Power & Performance on page 49	
PCH-FW Configuration	See 5.2.3. PCH-FW Configuration on page 52	
Trusted Computing	See 5.2.4. Trusted Computing on page 53	
ACPI Settings	See <u>5.2.5. ACPI Settings on page 55</u>	
F81966 Super IO Configuration See <u>5.2.6. F81966 Super IO Configuration of the configuration </u>		
Hardware Monitor	See <u>5.2.7</u> . Hardware Monitor on page <u>58</u>	
S5 RTC Wake Settings See <u>5.2.8. S5 RTC Wake Settings on page 59</u>		
Serial Port Console Redirection	See 5.2.9. Serial Port Console Redirection on page 60	
AMI Graphic Output Protocol Policy	See <u>5.2.10. AMI on page 61</u>	
USB Configuration See <u>5.2.11. USB Configuration on page 62</u>		
Network Stack Configuration	See <u>5.2.12</u> . Network Stack Configuration on page 64	
NVMe Configuration See <u>5.2.13. NVMe Configuration on page 65</u>		

# 5.2.1. CPU Configuration



Setting	Description	
Efficient-core Information	Display the E-core Information	
Performance-core Information	Display the P-core information	
Intel (VMX) Virtualization	When enabled, a VMM can utilize the additional hardware capabilities provided by Vanderpool Technology	
Technology	► Options: Enabled (default) or Disabled	
Active Processor-Cores	Number of cores to enable in each processor package.	
Active Processor-Cores	▶ Options: All (default), 1, 2 and 3.	
Active Efficient-Cores	Number of cores to enable in each processor package.	
	This item is used to enable or disable the processor's Hyper-threading feature.	
Hyper-Threading	Enabled for Windows XP and Linux (OS optimized for Hyper-threading Technology) and disabled for other OS (OS not optimized for Hyper-threading Technology).	
	When disabled, only one thread per enabled core is enabled.	
	Options: Enabled (default) or Disabled	
	* This setting may not be available depending on the CPU.	

#### 5.2.2. Power & Performance



Setting	Description
CPU - Power Management	Configure CPU Power Management
Control	See <u>5.2.2.1. CPU - Power Management Control On page 50</u>
GT - Power Management	Configure graphics processors Power Management
Control	See <u>5.2.2.2. GT - Power Management Control On page 51</u>

# 5.2.2.1. CPU - Power Management Control



Setting	Description	
Doct morformore Mode	Set the performance state that the BIOS will set before the OS handoff.	
Boot performance Mode	Options: Max Non-Turbo Performance (default), Max Battery and Turbo Performance	
Intel (R) Speed Step (tm)	Enable (default) / Disable Intel SpeedStep	
C States	Enable / Disable (default) CPU C States	

# 5.2.2.2. GT - Power Management Control

Advanced	Aptio Setup – AMI	
GT – Power Management Control		Check to enable render standby
RC6(Render Standby) Maximum GT frequency Disable Turbo GT frequency	[Enabled] [Default Max Frequency] [Disabled]	++: Select Screen  14: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F9: Optimized Defaults F10: Save & Exit ESC: Exit
Version 2	.22.1287 Copyright (C) 2023	AMI

Setting	Description	
RC6 (Render Standby)	Function of activation and deactivation the energy-saving mechanism integrated into the Intel graphics core processors when the computer enters sleep mode.	
	Enable (default) / Disable	
Maximum GT frequency	This item maximum GT frequency limited by te user. Value beyond the range will be clipped to min/max supported by SKU.	
	Default Max Frequency (default)	
Disable Turbo GT	This item Disable Turbo GT frequency. <b>Enabled</b> : Disables Turbo GT frequency. <b>Disabled</b> : GT frequency is no limited.	
frequency	Disabled (Default) / Enabled	

# **5.2.3. PCH-FW Configuration**

Advanced	Aptio Setup – AMI	
ME Firmware Version ME Firmware Mode ME Firmware SKU ME Firmware Status 1 ME Firmware Status 2 ME Firmware Status 3 ME Firmware Status 4 ME Firmware Status 5 ME Firmware Status 6 PTT Configuration	16.1.25.2101 Normal Mode Consumer SkU 0x90000255 0x8B100106 0x00000020 0x00004000 0x00000000	Configure PTT
	Persion 2.22.1289 Copyright (C)	f1: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F9: Optimized Defaults F10: Save & Exit ESC: Exit

Setting	Description
PTT Configuration	Select TPM device: PTT or dPTM. PTT - Enables PTT in SKuMgr dTPM1.2 - Disables PTT in SKuMgr Warning! PTT/dTPM will be disabled and all data saved on it will be lost.
	Options: dTPM (default) / PTT

# 5.2.4. Trusted Computing

Advanced	Aptio Setup – AMI	
Advanced  TPM 2.0 Device Found Firmware Version: Vendor:  Security Device Support Active PCR banks Available PCR banks  SHA256 PCR Bank  Pending operation Platform Hierarchy Storage Hierarchy Endorsement Hierarchy Physical Presence Spec Version TPM 2.0 InterfaceType Device Select	7.63 IFX  [Enable] SHA256 SHA256  [Enabled] [None] [Enabled] [Enabled] [Enabled] [Inabled] [Inabled] [Auto]	Enables or Disables BIOS support for security device. O.S. will not show Security Device. TCG EFI protocol and INTIA interface will not be available.  ++: Select Screen 11: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F9: Optimized Defaults F10: Save & Exit ESC: Exit
Version	2.22.1287 Copyright (C) 20	3 AMI

Setting	Description
Security Device Support	This item enables or disables BIOS support for security device. OS will not show Security Device.
	Enabled (Default) / Disabled
SUASES DOD Book	Enables or disables SHA-1 PCR Bank.
SHA256 PCR Bank	Enabled (Default) / Disabled
Pending operation	This item schedule an operation for the security device.
	None (Default) / TPM Clear
Platform Hierarchy	Enables or disables Platform Hierarchy
	Enabled (Default) / Disabled
Storage Hierarchy	Enables or disables Storage Hierarchy
	Enabled (Default) / Disabled
Endorsement Hierarchy	Enables or disables Endorsement Hierarchy.
	Enabled (Default) / Disabled

Physical Presence Spec Version	This item select to tell O.S. to support PPI Spec Version 1.2 or 1.3.  Options are: <b>1.3</b> (Default) / <b>1.2</b>	
Device Select	TPM 1.2 will restruct support to TPM 1.2 devices, TPM 2.0 will restrict support to TPM 2.0 devices, Auto will support both TPM 2.0 devices and TPM 1.2 deviced.	
	Options are: Auto(Default)/TPM 1.2/TPM 2.0	

# 5.2.5. ACPI Settings

Advanced	Aptio Setup – AMI	
ACPI Settings		Enables or Disables System
Enable Hibernation ACPI Sleep State	[Enabled] [S3 (Suspend to RAM)]	ability to Hibernate (OS/S4 Sleep State). This option may not be effective with some operating systems.  ++: Select Screen 11: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F9: Optimized Defaults F10: Save & Exit ESC: Exit
1	version 2.22.1287 Copyright (C) 20	23 AMI

Setting	Description
Enable Hibernation	<b>Enable</b> (default) or <b>Disable</b> system ability to Hibernate (OS/S4 Sleep State). This option may not be effective with some operating system.
	Only available when BIOS ACPI Auto Configuration is enabled.
ACPI Sleep State	Select ACPI sleep state the system will enter when the SUSPEND button is pressed.
	Options: Suspend Disabled and S3 (Suspend to RAM) (default)

## 5.2.6. F81966 Super IO Configuration



Note: The quantity of serial ports varies according to your model.

Setting	Description	
	To configure each COM port settings.	
	Serial Port 1:	
	▶ Options: Enable and Disable Serial Port (COM) (default)	
	Serial Port2:	
	► Options: Enable and Disable Serial Port (COM) (default)	
Serial Port 1/2/3/4 Configuration	<ul> <li>Options: Mode Select for RS-232 (default) RS-422, RS-422(Termination Resistor), RS-485, RS-485(Termination Resistor)</li> </ul>	
	Serial Port3:	
	► Options: Enable and Disable Serial Port (COM) (default)	
	<ul> <li>Options: Mode Select for RS-232 (default) RS-422, RS-422(Termination Resistor), RS-485, RS-485(Termination Resistor)</li> </ul>	
	Serial Port4:	
	▶ Options: Enable and Disable Serial Port (COM) (default)	
	Note: The quantity of serial ports varies according to your model.	
Power on after Power fail	Specify what state to go to when power is re-applied after a power failure(G3 state)	
	▶ Options: Always on (default) or Always off.	

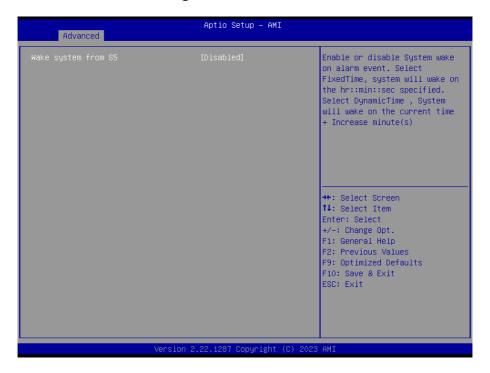
#### 5.2.7. Hardware Monitor



Access this submenu to monitor the hardware status.

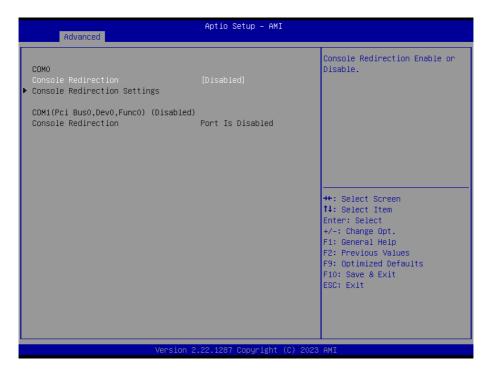
Setting	Description
Smart Fan Function	Enable or Disable Fan1 Output Mode Selection.  ► Fan Mode Options available are: Auto - Duty Cycle (default) Manual - Duty Cycle

# 5.2.8. S5 RTC Wake Settings



Setting	Description
	Enable or Disable (default) system wake on alarm event.
Wake System from S5	<ul> <li>Options available are:</li> <li>Disabled (default):</li> <li>Fixed Time: System will wake on the hr::min::sec specified.</li> <li>DynamicTime: If selected, you need to set Wake up minute increase from 1 - 5. System will wake on the current time + increase minute(s).</li> </ul>

#### 5.2.9. Serial Port Console Redirection



Setting	Description
Console Redirection	Console Redirection Enalble or Disable

#### 5.2.10. AMI



# The features settings are:

Setting	Description	
Output select	Output Select	

# 5.2.11. USB Configuration

Advanced	Aptio Setup – AMI	
USB Configuration		Enables Legacy USB support. AUTO option disables legacy
USB Module Version	30	support if no USB devices are connected. DISABLE option will
USB Controllers:		keep USB devices available only for EFI applications.
USB Devices:		oning for Eri applications.
1 Drive, 2 Keyboards, 1 Mouse		
Legacy USB Support		
XHCI Hand-off	[Enabled]	
USB Mass Storage Driver Support	[Enabled]	
USB hardware delays and time-outs:		→+: Select Screen
USB transfer time-out	[20 sec]	↑↓: Select Item
Device reset time-out	[20 sec]	Enter: Select
Device power-up delay	[Auto]	+/-: Change Opt. F1: General Help
Mass Storage Devices:		F2: Previous Values
VendorCoProductCode 2.00	[Auto]	F9: Optimized Defaults
		F10: Save & Exit
		ESC: Exit
Version 2	.22.1287 Copyright (C) 2023	3 AMI

Setting	Description
	Enables/disables legacy USB support.
Legacy USB Support	Options available are Enabled (default), Disabled and Auto.
	Select Auto to disable legacy support if no USB device are connected.
	Select Disabled to keep USB devices available only for EFI applications.
XHCI Hand-off	This is a workaround for OSes without XHCI hand-off support. The XHCI ownership change should be claimed by XHCI driver.
	► The optional settings are: <b>Enabled</b> (default) / <b>Disabled</b> .
USB Mass Storage	Enables/disables USB Mass Storage Driver Support.
Driver Support	► The optional settings are: <b>Enabled</b> (default) / <b>Disabled</b> .

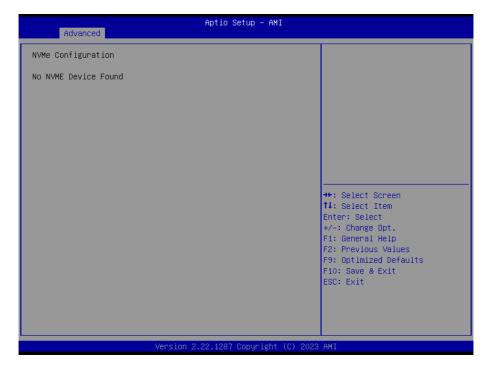
USB hardware delay and time-out	
USB transfer time-	Use this item to set the time-out value for control, bulk, and interrupt transfers.
out	▶ Options: 1 sec, 5 sec, 10 sec, 20 sec (default)
Device reset time-	Use this item to set USB mass storage device start unit command time- out.
out	▶ Options available are: 10 sec, 20 sec (default)., 30 sec, 40 sec
	Use this item to set maximum time the device will take before it properly reports itself to the host controller. 'Auto' uses default value: for a root port it is 100 ms, for a hub port the delay is taken from hub descriptor.
Device power-up delay	Options available are:     Auto: Default     Manual: Select Manual you can set value for the following sub-item:     'Device Power-up delay in seconds', the delay range in from 1 to 40 seconds, in one second increments.

## 5.2.12. Network Stack Configuration



Setting	Description
Network Stack	Enable or Disable (default) UEFI network stack.

### 5.2.13. NVMe Configuration



Access this submenu to view the NVMe controller and driver information.

# 5.3. Chipset



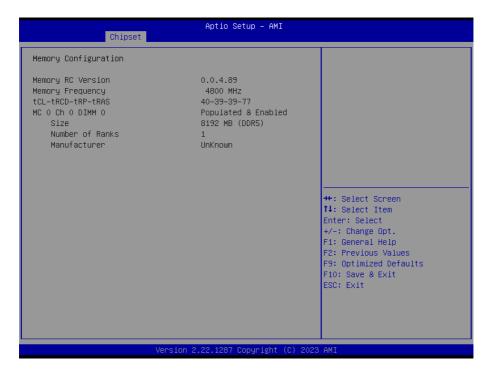
Submenu	Description
System Agent (SA) Configuration	See 5.3.1. System Agent (SA) Configuration on page 67
PCH-IO Configuration	See 5.3.1.3 VMD Configuration on page 70

### 5.3.1. System Agent (SA) Configuration



Submenu	Description
System Agent (SA) Configuration	
Memory Configuration	See 5.3.1.1. Memory Configuration on page 68
Graphics Configuration	See 5.3.1.2. Graphics Configuration on page 69
VMD setup menu	Enabled (default) or Disabled to VMD controller
VT-d	Enabled (default) or Disabled VT-d function

### 5.3.1.1. Memory Configuration



Access this submenu to view the memory configuration.

### 5.3.1.2. Graphics Configuration



Note: This page varies according to your model.

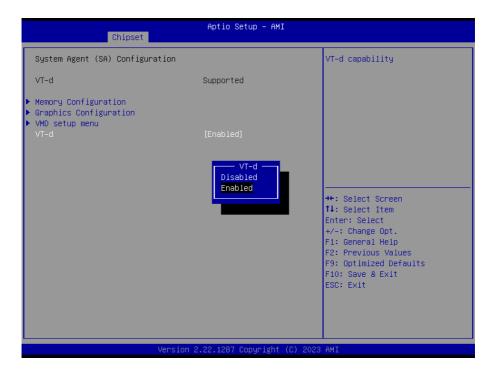
Setting	Description	
<b>Graphics Turbo IMON Current</b>	Graphics turbo IMON current values supported(14-31)	
Primary Display	Select which of IGFX/PEG/PCI Graphics device should be Primary Display or select HG for Hybrid GFX.  Options: Auto, IGFX, PEG Slot, PCH PCI, HG	
Aperture Size	Select the Aperture Size  Options: 128MB, 256MB (default), 512MB and 1024MB.	
DVMT Pre-Allocated	Select the DVMT 5.0 Pre-allocated (Fixed) Graphic Memory size used by the Internal Graphic Device.  • 60M is the default.	
DVMT Total Gfx Mem	Select the DVMT 5.0 Total Graphic Memory size used by the Internal Graphic Device.  • Options: 128MB, 256MB (default) and Max.	

### 5.3.1.3 VMD Configuration



Setting	Description	
Enable VMD controller	Enablee/Disable to VMD controller	
	➤ Options: Enabled, Disabled(default).	

#### 5.3.1.4 VT-d



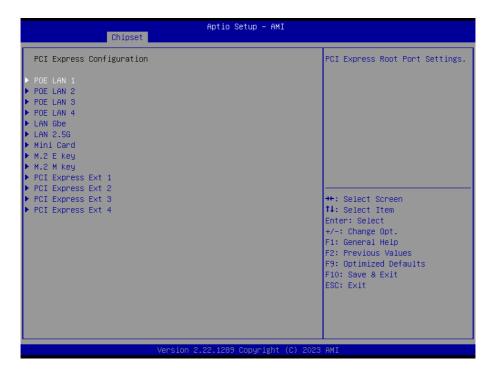
Setting Description	
VT-d	Enablee/Disable VT-d capability
VI-u	Options: Enabled (default), Disabled.

### 5.3.2. PCH-IO Configuration



Setting Description	
PCI Express Configuration	See 5.3.2.1. PCI Express Configuration on page 73
SATA Configuration	See 5.3.2.2. SATA Configuration on page 74
PCH LAN Controller	Enable/Disable onboard NIC.  Options are: Enabled (default), Disabled.

## 5.3.2.1. PCI Express Configuration



Setting	Description	
	POE LAN 1-4: Control the PCI Express Root Port.	
	Options are: Enabled (default), Disabled.	
	ASPM: Set the ASPM level	
POE LAN1 - 4	Options are: Disabled (default), L1, Auto	
POE LANT - 4	L1 Substates: PCI Express L1 Substates settings.	
	➤ Options are: <b>Disabled</b> (default), <b>L1.1</b> , <b>L1.1 &amp; L1.2</b>	
	PCle Speed: Configure PCle Speed.	
	▶ Options are: Auto (default), Gen1, Gen2, Gen3, Gen4	
LAN Gbe	PCI Express root port setings. Control the LAN Gbe root port.	
LAN 2.5G	PCI Express root port setings. Control the LAN 2.5G root port.	
Mini Card	Configure Mini Card settings.	
M.2 E-key	PCI Express root port setings. Control the M.2 E-key root port.	
M.2 B-key	PCI Express root port setings. Control the M.2 B-key root port.	

# **5.3.2.2. SATA Configuration**

Aptio Setup – AMI Chipset		
SATA Configuration		Enable/Disable SATA Device.
SATA Controller(s)		
Serial ATA Port 0 Software Preserve Port 0 SATA Port 0 DevSlp Serial ATA Port 1 Software Preserve Port 1	Empty Unknown [Enabled] [Disabled]  Empty Unknown [Enabled]	
SATA Port 1 DevSlp	[Disabled]	++: Select Screen  †1: Select Item Enter: Select +/-: Change Opt.  F1: General Help F2: Previous Values F9: Optimized Defaults F10: Save & Exit ESC: Exit
<u> </u>	ersion 2.22.1287 Copyright (C	) 2023 AMI

Setting	Description	
SATA Controller(s)	Enables (default) / disables SATA device(s).	
Serial ATA Port 0/1	SATA device information.  *Available SATA ports depend on your device.	
Port 0/1	Enables (default) / disables the SATA port.	
SATA Port 0/1 DevSlp	Enables / disables (default) the SATA port DevSlp. Board rework for LP needed before enable.	

### 5.4. Security



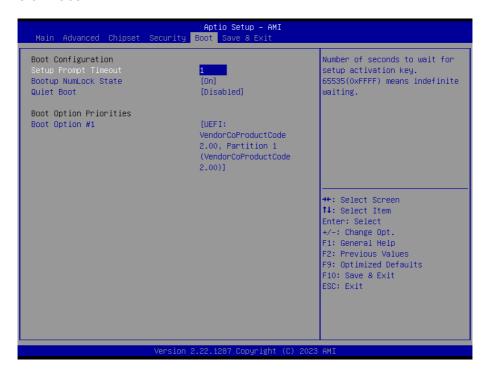
Setting	Description	
	To set up an administrator password:	
	Select Administrator Password.	
Administrator	An Create New Password dialog then pops up onscreen.	
Password	3. Enter your desired password that is no less than 3 characters and no more than 20 characters.	
	4. Hit [Enter] key to submit.	
Security Boot	See <u>5.4.1 Security Boot on page 76</u>	

### 5.4.1 Security Boot



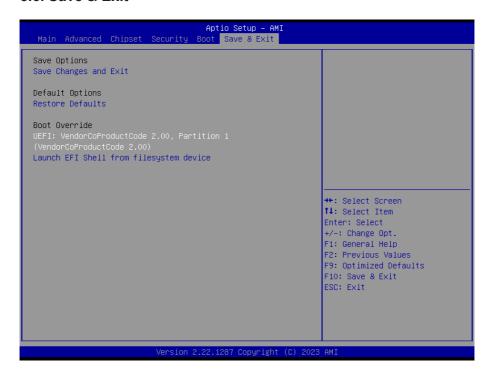
Setting	Description	
Secure Boot	Enabled/Disabled (default) secure boot.	
Secure Boot Mode	Allow users to set the secure boot selector.	
	Options are: Standard/Custome (default) mode.	
Restore Factory Keys	Force system to restore default secure boot key database.	
Reset to Setup Mode	Delete all secure boot key databases.	
Key Management	Allow users to modify secure variables and set key management page.	

#### 5.5. Boot



Setting	Description	
Setup Prompt Timeout	Set how long to wait for the prompt to show for entering BIOS Setup.  The default setting is 1 (sec).  Set it to 65535 to wait indefinitely.	
Bootup NumLock State	Sets whether to enable or disable the keyboard's NumLock state when the system starts up.  Options available are <b>On</b> (default) and <b>Off</b> .	
Quiet Boot  Sets whether to display the POST (Power-on Self Tests) m or the system manufacturer's full screen logo during bootin  Select Disabled to display the normal POST message, the default.		
<b>Boot Option Priority</b>	Set the system boot priorities.	

#### 5.6. Save & Exit



Setting	Description	
Save Changes and Exit	Saves the changes and quits the BIOS Setup utility.	
Restore Defaults	Restores all settings to defaults.	
	▶ This is a command to launch an action from the BIOS Setup utility.	
Boot Override	<b>Boot Override</b> presents a list in context with the boot devices in the system.	
	▶ <b>P0:</b> Select the device to boot up the system regardless of the currently configured boot priority.	
	► Launch EFI Shell from filesystem device: Attempts to launch EFI Shell Application (Shell.efi) from one of the available filesystem devices.	

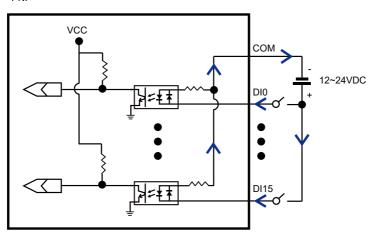
# **Appendix**

# Appendix A. 16-bit Opto-Isolated DI Signal Connections

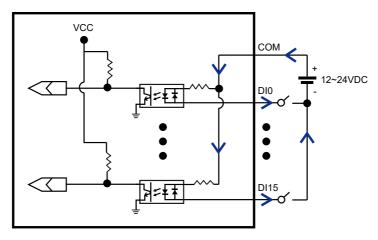
### A.1. Wet Contact DI with NPN / PNP connection

Digital Input - Wet Contact		
V <sub>off</sub>	<b>V</b> <sub>on</sub>	
Max. 3V	12~24V	

PNP

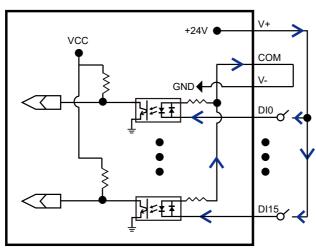


NPN

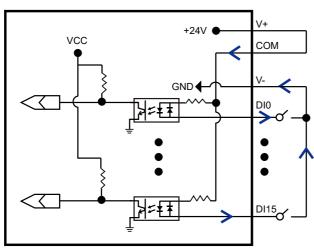


# A.2. Dry Contact DI with NPN / PNP connection





#### NPN



### Appendix B. 16-bit Opto-Isolated DO Signal Connections

## **B.1. DO Connection diagram**

When an isolated output channel is being used as an output channel, if an external voltage (maximum 24V) is applied, the current will flow from the external voltage source to the system. Make sure that the current through each out pin does not exceed 100 mA.

